

PRODUCT INFORMATION LETTER

PIL MMS-MMY/13/8226 Dated 22 Nov 2013

7 inch Reel change for WLCSP EEPROM in 12 mm tape

Sales Type/product family label	EEPROM products in WLCSP	
Type of change	Logistics process change	
Reason for change	Robustness improvement	
Description	Change for an improved 7 inch reel regarding robustness for WLCSP delivery.	
Forecasted date of implementation	15-Nov-2013	
Forecasted date of samples for customer	15-Nov-2013	
Forecasted date for STMicroelectronics change Qualification Plan results availability	15-Nov-2013	
Involved ST facilities	Back-End	

DOCUMENT APPROVAL

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A7/.



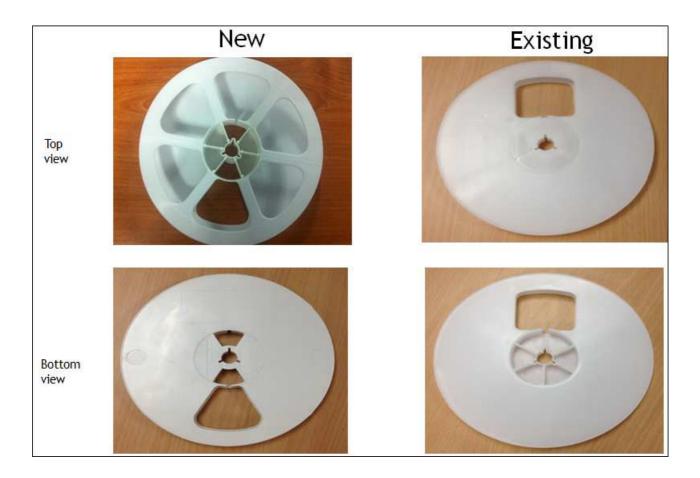
PRODUCT / PROCESS INFORMATION LETTER

7" Reel change for WLCSP EEPROM in 12 mm tape

Dear customer,

This information letter intends to inform you that the MMY Division of STMicroelectronics has decided to change the 7" reel, used to pack the WLCSP EEPROM in 12 mm tape width, to an **improved 7" reel** regarding **rigidity**.

There is no change at customer process. Improved reel 7" reel is showing **6 branches**, while current 7" reel is full, with no branches:



Notes:

- Improved 7" reel can be white, black or blue

Appendix A- Product Change Information

Product family / Commercial products:	EEPROM products in WLCSP
Customer(s):	All
Type of change:	Packing change
Reason for the change:	Robustness improvement
Description of the change:	Change for an improved 7" reel regarding robustness for WLCSP delivery.
Forecast date of the change: (Notification to customer)	Week 46 / 2013
Forecast date of Qualification samples availability for customer(s):	Not applicable
Marking to identify the changed product:	Not applicable
Product Line(s) and/or Part Number(s):	See Appendix B
Manufacturing location:	STATSChipPAC (Singapore)

Appendix B: concerned products:

COMMERCIAL PART NUMBERS
M24M01-DFCS6TP/K
M24M01-RCS6TP/A
M24M02-DRCS6TP/K
M95M01-DFCS6TP/K
M95M01-RCS6TP/A
M95M02-DRCS6TP/K

7" Reel change for WLCSP EEPROM in 12 mm tape

Document Revision History		
Date	Rev.	Description of the Revision
October 15, 2013	1.00	Creation
	1	

Source Documents & Reference Documents		
Source document Title	Re	v.: Date:

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